Toray MicroPly™ SF-5



Toray Advanced Composites

PRODUCT DATA SHEET

DESCRIPTION

Toray MicroPly™ SF-5 is a cyanate ester based syntactic film developed to be compatible with various cyanate ester matrices, including Toray RS-3. Toray MicroPly™ SF-5 is available in unsupported and supported continuous film form in thicknesses from 0.25–6.35 mm (10–250 mils). Toray MicroPly™ SF-5 has been evaluated and qualified in aerospace and dielectric structures.

FEATURES

- ▶ Minimum ambient work life of 4 weeks
- ► Good handleability, drape, and processing
- ► Good moisture resistance
- ► Good toughness
- ▶ Low dielectric and loss tangent over wide thermal and electrical ranges
- ▶ Out of autoclave/vaccuum bag. Press forming, post curable autoclave

PRODUCT TYPE

177°C (350°F) Cure Cyanate Ester Syntactic Film

PRODUCT FORMS

► Film to 127 cm (50") wide

TYPICAL APPLICATIONS

- ► Aerospace structures
- **▶** Radomes

SHELF LIFE

Out Life:	14 days out life \leq 21°C (70°F) and \leq 60% RH
Frozen Storage Life:	6 months at ≤-18°C (≤ 0°F)

Out life is the maximum time allowed at 21°C (70°F) or below and 60% or less RH before cure, after a single frozen storage cycle in the original unopened packaging at -18°C (0°F) or below for a period not exceeding the frozen storage life noted above.

TYPICAL NEAT RESIN PROPERTIES

Density	38 pcf, nom. (0.61 g/cc)		
Dry T _g (by DMA	254°C (490°F) cured 2 hours at 177°C (350°F) and post cured 2 hours at 232°C (450°F)		
Wet T _g (by DMA)	249°C (480°F) determined after exposure to 95% RH at 71°C (160°F) for 20 days		
Moisture Absorption*	3.5%		
Dielectric Constant	1.70 (at 18 GHz)		
Loss Tangent	0.004 (at 18 GHz)		

^{*} Equilibrated at 95% relative humidity and 71°C (160°F)



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SYNTACTIC FILM MECHANICAL PROPERTIES

Property Tensile Strength	Condition (Temperature)	Method ASTM D 638	Resi	Results	
	24°C (75°F)		20.2 MPa	2.93 ksi	
Tensile Modulus	24°C (75°F)	ASTM D 638	2.9 GPa	0.42 Msi	
Tensile Strength	75°C (167°F)	ASTM D 638	22.0 MPa	3.19 ksi	
Tensile Modulus	75°C (167°F)	ASTM D 638	2.7 GPa	0.39 Msi	
Tensile Strength	232°C (450°F)	ASTM D 638	26.9 MPa	3.90 ksi	
Tensile Strength	75°C (167°F) WET	ASTM D 638	20.2 MPa	2.93 ksi	
Tensile Modulus	75°C (167°F) WET	ASTM D 638	2.6 GPa	0.38 Msi	
Tensile Strength	177°C (350°F) WET	ASTM D 638	14.5 MPa	2.10 ksi	
Tensile Strength	-62°C (-80°F)	ASTM D 638	15.0 MPa	2.18 ksi	
Tensile Modulus	-62°C (-80°F)	ASTM D 638	3.2 GPa	0.47 Msi	
Poisson's Ratio				0.33	
Flexural Strength	25°C (77°F)	ASTM D 790	48.3 MPa	7.0 ksi	
Flexural Strength	232°C (450°F)	ASTM D 790	60.0 MPa	8.70 ksi	
Flexural Strength	177°C (350°F) WET	ASTM D 790	29.0 MPa	4.20 ksi	
Flatwise Compressive Strength	25°C (77°F)	ASTM D 365	79.3 MPa	11.50 ksi	
Notched Shear Strength	24°C (75°F)	ASTM D 5379	17.4 MPa	2.52 ksi	
Notched Shear Modulus	24°C (75°F)	ASTM D 5379	1.0 GPa	0.14 ksi	
Notched Shear Strength	75°C (167°F)	ASTM D 5379	12.8 MPa	1.86 ksi	
Notched Shear Modulus	75°C (167°F)	ASTM D 5379	1.0 GPa	0.14 Msi	
Notched Shear Strength	75°C (167°F) WET	ASTM D 5379	13.7 MPa	1.98 ksi	
Notched Shear Modulus	75°C (167°F) WET	ASTM D 5379	1.0 GPa	0.14 Msi	
Notched Shear Strength	-62°C (-80°F)	ASTM D 5379	10.9 MPa	1.58 ksi	
Notched Shear Modulus	-62°C (-80°F)	ASTM D 5379	1.0 GPa	0.14 Msi	

CURE PARAMETERS

- ► Apply vacuum. For autoclave or press applications, pressurize to 45–100 psi
- ► Heat to 177°C ± 5°C (350°F ± 10°F) at 3°C ± 2°C/min (5°F ± 3°F/min)
- ► Hold at 177°C (350°F) for 2 hours (±15 min). Cool. May be post cured at 232°C (450°F) if higher temperature service is required

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